

SMD Comm X8L HT150C, Ceramic, 3.3 uF, 10%, 25 VDC, X8L, SMD, MLCC, High Temperature, Temperature Stable, 1210



Dimensions

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
T	1.7mm +/-0.20mm
B	0.6mm +/-0.25mm

Packaging Specifications

Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information

Series:	SMD Comm X8L HT150C
Style:	SMD Chip
Description:	SMD, MLCC, High Temperature, Temperature Stable
Features:	High Temperature, Temperature Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	85 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	3.3 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	10%
Voltage DC:	25 VDC
Dielectric Withstanding Voltage:	62.5 VDC
Temperature Range:	-55/+150°C
Temperature Coefficient:	X8L
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	+15%/-40%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	151.5 MOhms

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)